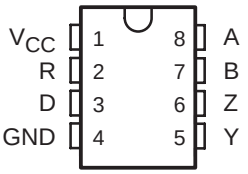
SLLS123B − D2845, JUNE 1984 − REVISED FEBRUARY 1993

- **Meets EIA Standards RS-422A, RS423A, and CCITT Recommendations V.11 and X.27**
- **Bus Voltage Range . . . −7 V to 12 V**
- **Positive and Negative Current Limiting**
- **Driver Output Capability . . . 60 mA Max**
- **Driver Thermal Shutdown Protection**
- **Receiver Input Impedance . . . 12 kΩ Min**
- **Receiver Input Sensitivity . . . ±200 mV**
- **Receiver Input Hysteresis . . . 50 mV Typ**
- **Operates From Single 5-V Supply**
- **Low Power Requirements**

D OR P PACKAGE
(TOP VIEW)



NOT RECOMMENDED FOR NEW DESIGN

description

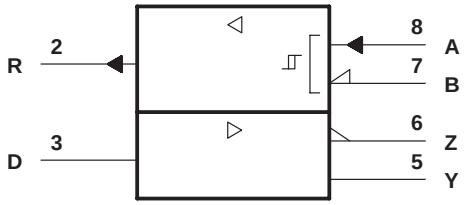
The SN75179A driver and bus receiver circuit is a monolithic integrated device designed for balanced transmission line applications, and meets EIA Standards RS-422A, RS-423A, and CCITT Recommendations V.11 and X.27. It is designed to improve the performance of data communications over long bus lines.

The SN75179A features positive- and negative-current limiting for the driver and receiver. The receiver features high input impedance, input hysteresis for increased noise immunity, and input sensitivity of ±200 mV over a common-mode input voltage range of −12 V to 12 V.

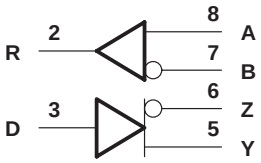
The driver provides thermal shutdown for protection from line fault conditions. Thermal shutdown is designed to occur at a junction temperature of approximately 150°C. The device is designed to drive current loads of up to 60 mA maximum.

The SN75179A is characterized for operation from 0°C to 70°C.

logic symbol



logic diagram



Function Tables

DRIVER

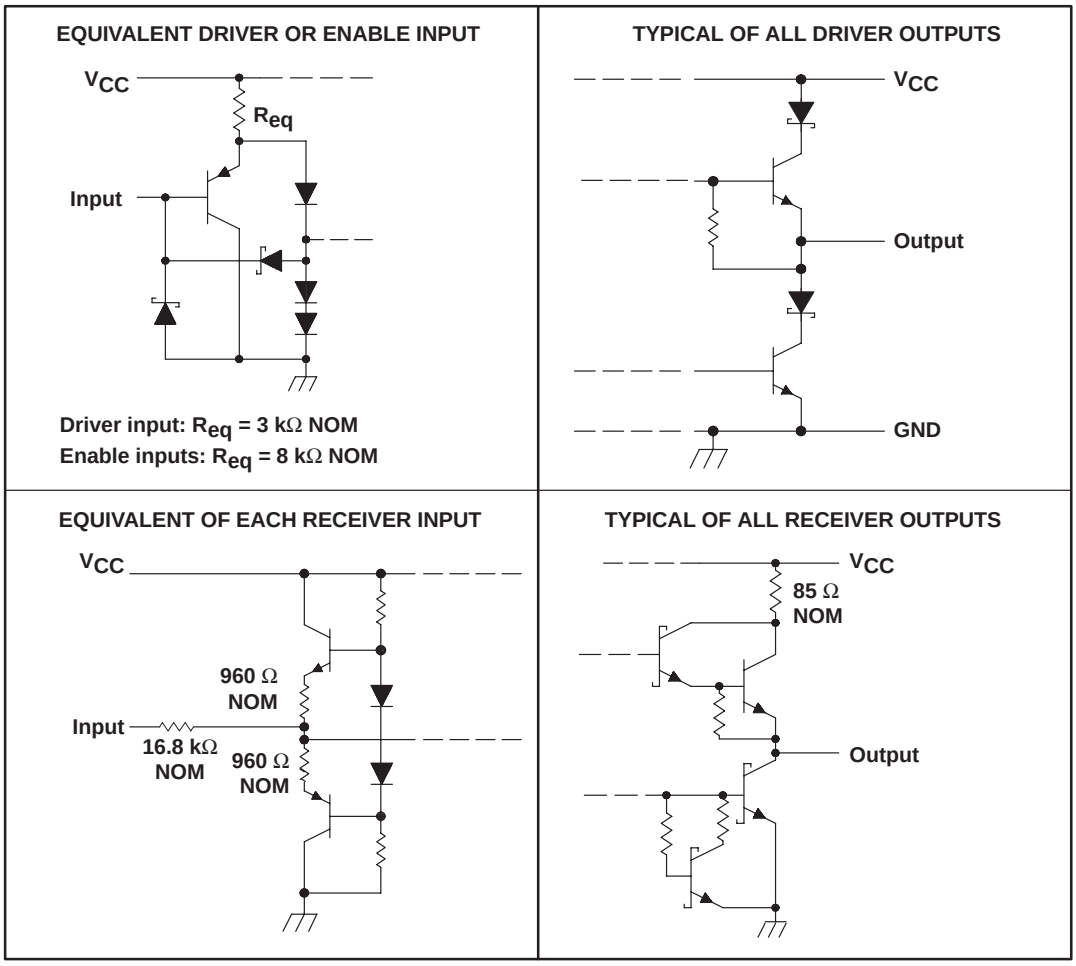
INPUT D	OUTPUTS Y	OUTPUTS Z
H	H	L
L	L	H

RECEIVER

DIFFERENTIAL INPUTS A − B	OUTPUT R
$V_{ID} \geq 0.2$ V	H
$-0.2\text{ V} < V_{ID} < 0.2\text{ V}$	?
$V_{ID} \leq -0.2$ V	L

H = high level, L = low level, ? = indeterminate

schematics of inputs and outputs



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Voltage range at any bus terminal . . . . . −10 V to 15 V
Differential input voltage (see Note 2) . . . . . ±25 V
Continuous total dissipation . . . . . See Dissipation Rating Table
Operating free-air temperature range . . . . . 0°C to 70°C

NOTES: 1. All voltage values, except differential input voltage, are with respect to network ground terminal.
2. Differential-input voltage is measured at the noninverting input with respect to the corresponding inverting input.

DISSIPATION RATING TABLE

PACKAGE	$T_A \le 25°C$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25°C$	$T_A = 70°C$ POWER RATING
D	725 mW	5.8 mW/°C	464 mW
P	1000 mW	8.0 mW/°C	640 mW

recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, V_{CC}		4.5	5	5.25	V
High-level input voltage, V_{IH}	Driver	2			V
Low-level input voltage, V_{IL}	Driver			0.8	V
Common-mode input voltage, V_{IC}		−7†		12	V
Differential input voltage, V_{ID}				±12	V
High-level output current, I_{OH}	Driver			−60	mA
	Receiver			−400	µA
Low-level output current, I_{OL}	Driver			60	mA
	Receiver			8	
Operating free-air temperature, T_A		0		70	°C

† The algebraic convention, where the less-positive (more-negative) limit is designated minimum, is used in this data sheet for common-mode input voltage and threshold voltage.

DRIVER SECTION

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP‡	MAX	UNIT
V_{IK}	Input clamp voltage	I_I = −18 mA				−1.5	V
V_{OH}	High-level output voltage	V_{IH} = 2 V, I_{OH} = −33 mA	V_{IL} = 0.8 V,		3.7		V
V_{OL}	Low-level output voltage	V_{IH} = 2 V, I_{OH} = 33 mA	V_{IL} = 0.8 V,		1.1		V
$\|V_{OD1}\|$	Differential output voltage	I_O = 0				2 V_{OD2}	V
$\|V_{OD2}\|$	Differential output voltage	R_L = 100 Ω,	See Figure 13	2	2.7		V
		R_L = 54 Ω,	See Figure 13	1.5	2.4		
$\Delta\|V_{OD}\|$	Change in magnitude of differential output voltage§	R_L = 54 Ω or 100 Ω,	See FIgure 13			±0.2	V
V_{OC}	Common-mode output voltage¶					3	V
$\Delta\|V_{OC}\|$	Change in magnitude of common-mode output voltage§					±0.2	V
I_O	Output current with power off	V_{CC} = 0,	V_O = −7 V to 12 V			±100	µA
I_{IH}	High-level input current	V_I = 2.4 V				20	µA
I_{IL}	Low-level input current	V_I = 0.4 V				−400	µA
I_{OS}	Short-circuit output current	V_O = −7 V				−250	mA
		V_O = V_{CC}				250	
		V_O = 12 V				500	
I_{CC}	Supply current (total package)	No load				50	mA

‡ All typical values are at V_{CC} = 5 V and T_A = 25°C.

§ $\Delta|V_{OD}|$ and $\Delta|V_{OC}|$ are the changes in magnitude of V_{OD} and V_{OC}, respectively, that occur when the input is changed from a high level to a low level.

¶ In EIA Standard RS-422A, V_{OC}, which is the average of the two output voltages with respect to ground, is called output offset voltage, V_{OS}.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{dD}	Differential-output delay time	R_L = 60 Ω, See Figure 3		40	60	ns
t_{tD}	Differential-output transition time			65	95	ns

RECEIVER SECTION

electrical characteristics over recommended ranges of common-mode input voltage, supply voltage, and operating free-air temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP†	MAX	UNIT
V_{T+}	Positive-going threshold voltage	V_O = 2.7 V,	I_O = −0.4 mA			0.2	V
V_{T-}	Negative-going threshold voltage	V_O = 0.5 V,	I_O = 8 mA	−0.2‡			V
V_{hys}	Hysteresis ($V_{T+} - V_{T-}$)	See Figure 9			50		mV
V_{OH}	High-level output voltage	V_{ID} = 200 mV, See Figure 2	I_{OH} = −400 µA,	2.7			V
V_{OL}	Low-level output voltage	V_{ID} = −200 mV,	I_{OL} = 8 mA, See Figure 2			0.45	V
I_I	Line input current	Other input at 0 V, See Note 3	V_I = 12 V			1	mA
			V_I = −7 V			−0.8	
r_i	Input resistance			12			kΩ
I_{OS}	Short-circuit output current			−15		−85	mA
I_{CC}	Supply current (total package)	No load				50	mA

† All typical values are at V_{CC} = 5 V, T_A = 25°C.
‡ The algebraic convention, where the less-positive (more-negative) limit is designated minimum, is used in this data sheet for common-mode input voltage and threshold voltage levels only.
NOTE 3: Refer to EIA Standard RS-422A for exact conditions.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	Propagation delay time, low-to-high-level output	V_{ID} = −1.5 V to 1.5 V, C_L = 15 pF, See Figure 5		26	35	ns
t_{PHL}	Propagation delay time, high-to-low-level output			27	35	ns

PARAMETER MEASUREMENT INFORMATION

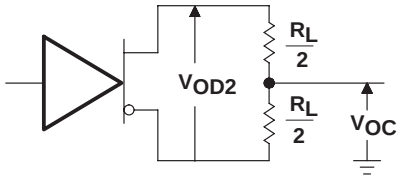


Figure 1. Driver V_{OD} and V_{OC}

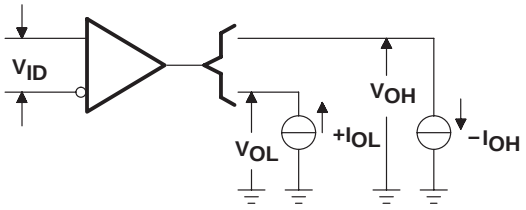


Figure 2. Receiver V_{OH} and V_{OL}

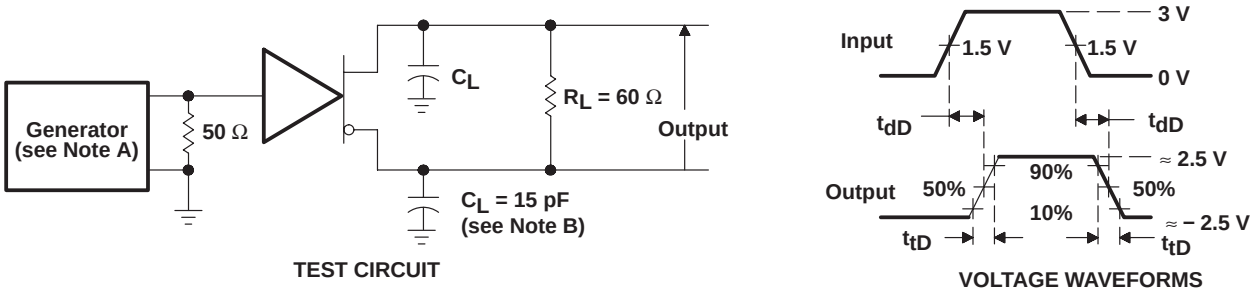


Figure 3. Driver Differential-Output Delay and Transition Times

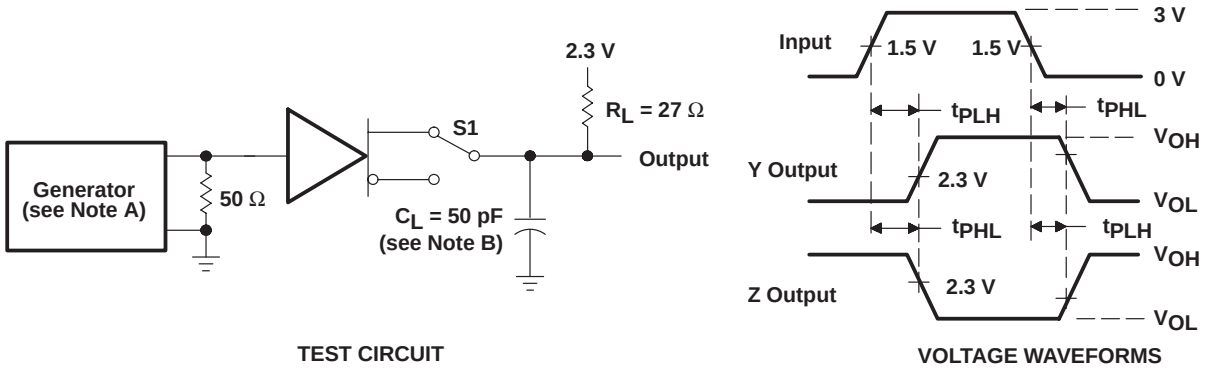


Figure 4. Driver Test Circuit and Voltage Waveforms

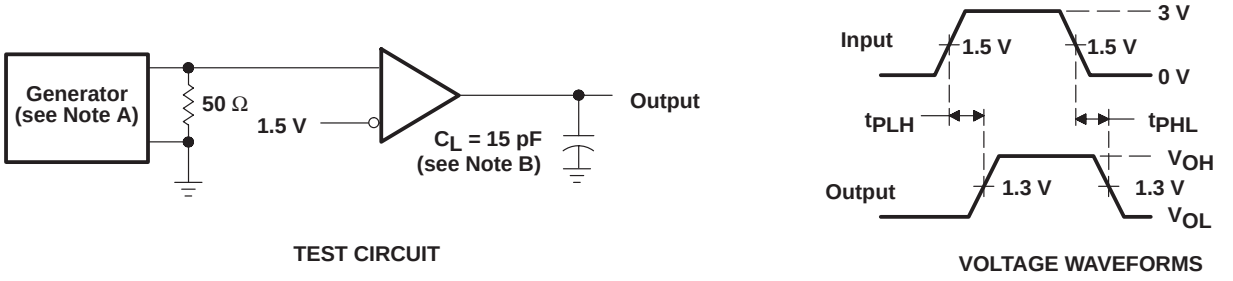


Figure 5. Receiver Test Circuit and Voltage Waveforms

NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, 50% duty cycle, $t_r \le 6$ ns, $t_f \le 6$ ns, $Z_O = 50\ \Omega$.
B. C_L includes probe and jig capacitance.

TYPICAL CHARACTERISTICS

DRIVER HIGH-LEVEL OUTPUT VOLTAGE vs DRIVER HIGH-LEVEL OUTPUT CURRENT

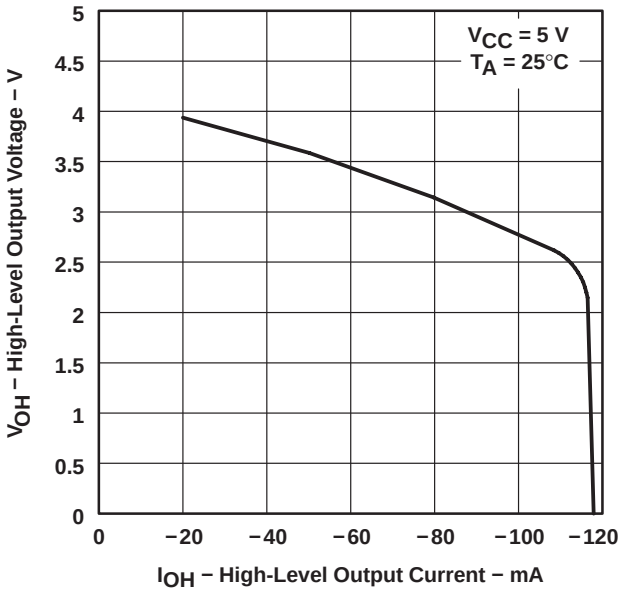


Figure 6

DRIVER LOW-LEVEL OUTPUT VOLTAGE vs DRIVER LOW-LEVEL OUTPUT CURRENT

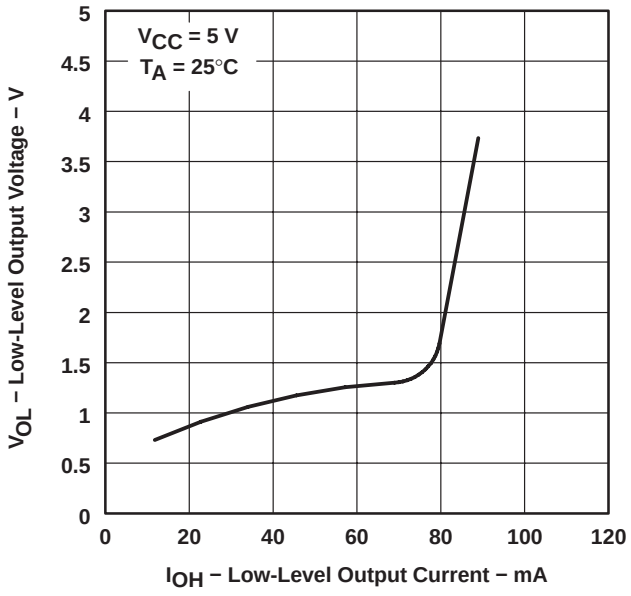


Figure 7

DRIVER DIFFERENTIAL OUTPUT VOLTAGE vs DRIVER OUTPUT CURRENT

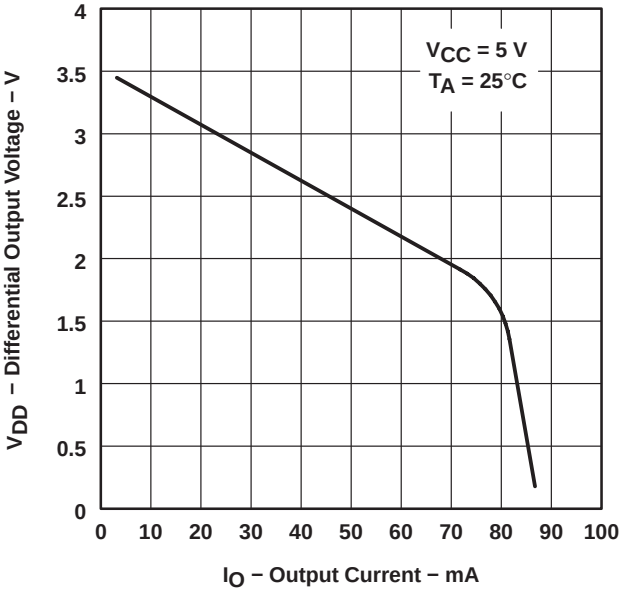


Figure 8

RECEIVER OUTPUT VOLTAGE vs DIFFERENTIAL INPUT VOLTAGE

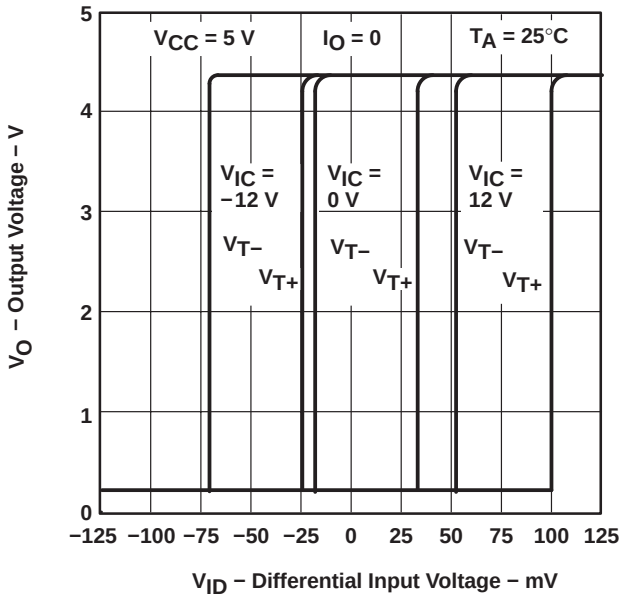


Figure 9

TYPICAL CHARACTERISTICS

RECEIVER HIGH-LEVEL OUTPUT VOLTAGE vs HIGH-LEVEL OUTPUT CURRENT

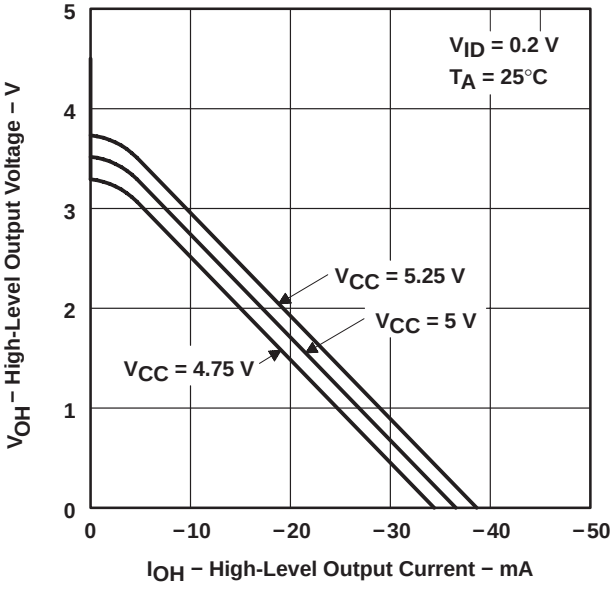


Figure 10

RECEIVER HIGH-LEVEL OUTPUT VOLTAGE vs FREE-AIR TEMPERATURE

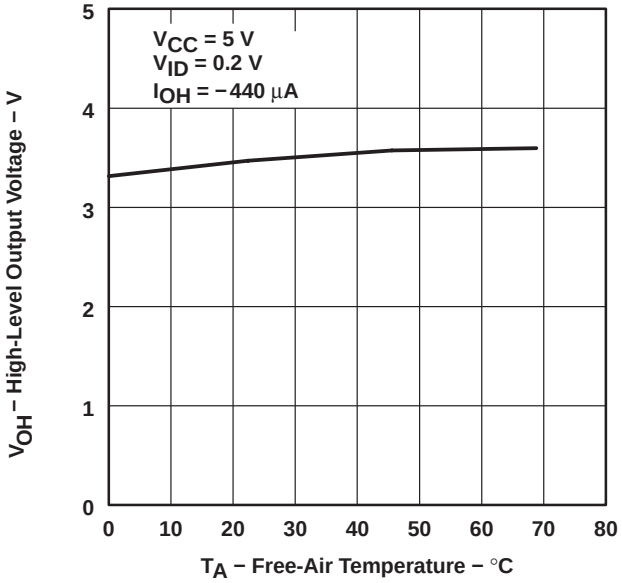


Figure 11

RECEIVER LOW-LEVEL OUTPUT VOLTAGE vs RECEIVER LOW-LEVEL OUTPUT CURRENT

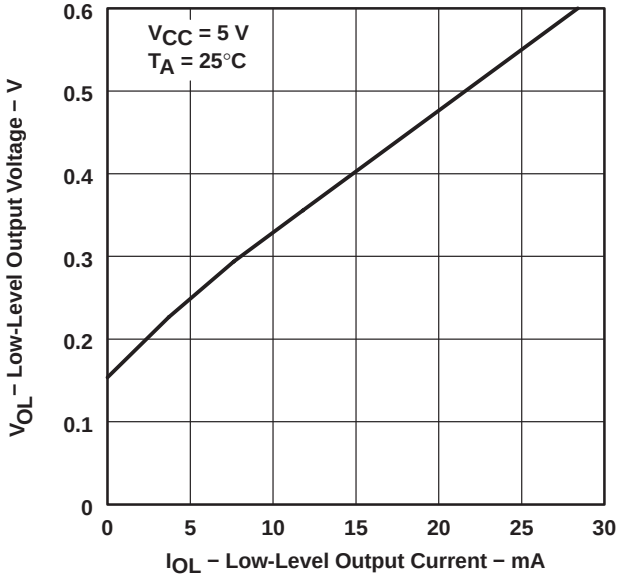


Figure 12

RECEIVER LOW-LEVEL OUTPUT VOLTAGE vs FREE-AIR TEMPERATURE

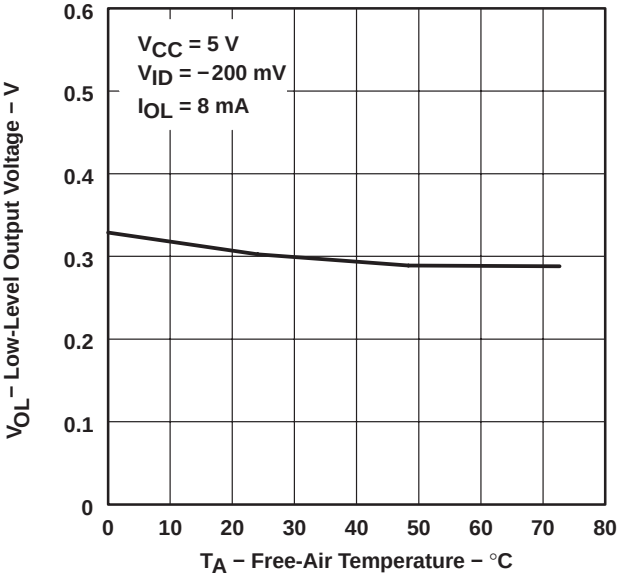


Figure 13

PACKAGING INFORMATION

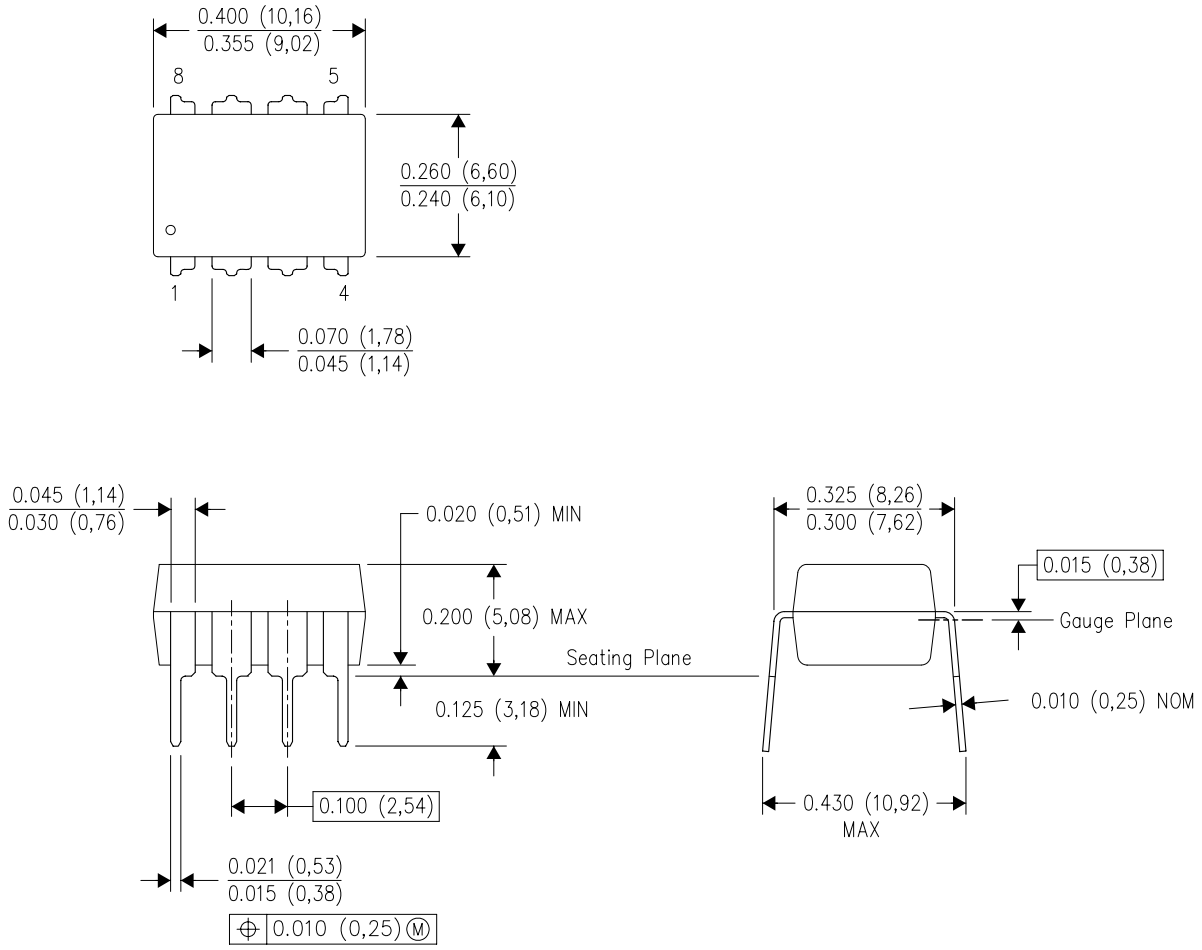
Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/ Ball Finish	MSL Peak Temp (3)	Samples (Requires Login)
SN75179AP	OBSOLETE	PDIP	P	8		TBD	Call TI	Call TI	Samples Not Available

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

P (R–PDIP–T8) PLASTIC DUAL–IN–LINE PACKAGE



NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS–001 variation BA.

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